

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/853,083	05/10/2001	Kenji Uchiyama	9319S-000204	5266
27572 7:	590 08/22/2002			
HARNESS, DICKEY & PIERCE, P.L.C. P.O. BOX 828 BLOOMFIELD HILLS, MI 48303			EXAMINER	
			RUDE, TIMOTHY L	
			ART UNIT	PAPER NUMBER
			2871	
			DATE MAILED: 08/22/2002	

Please find below and/or attached an Office communication concerning this application or proceeding.

. •		Application No.	Applicant(s)	
	•	09/853,083	UCHIYAMA, KENJI	
Office Action Summary		Examin r	Art Unit	
	•	Timothy L Rude	2871	
<u> </u>	The MAILING DATE of this communication app	<u>-</u>		
Period fo			•	
THE - Exte after - If the - If NO - Failt - Any	ORTENED STATUTORY PERIOD FOR REPLY MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. The period for reply specified above is less than thirty (30) days, a reply operiod for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, within the statutory minimur will apply and will expire SIX (cause the application to bee	may a reply be timely filed n of thirty (30) days will be considered timely. 5) MONTHS from the mailing date of this communication. ome ABANDONED (35 U.S.C. § 133).	
1)⊠	Responsive to communication(s) filed on 22 /	March 2002 .		
2a)⊠	This action is FINAL . 2b) Th	is action is non-final.		
3)	Since this application is in condition for allowa closed in accordance with the practice under			
Ī	ion of Claims			
4)⊠	Claim(s) 1-25 is/are pending in the application			
	4a) Of the above claim(s) is/are withdraw	wn from consideratio	n.	
	Claim(s) is/are allowed.			
	Claim(s) <u>1-25</u> is/are rejected.			
•	Claim(s) is/are objected to.			
•	Claim(s) are subject to restriction and/or ion Papers	r election requireme	it.	
	The specification is objected to by the Examine	r		
, —	The drawing(s) filed on is/are: a) accept		b by the Examiner	
10)	Applicant may not request that any objection to the			
11)	The proposed drawing correction filed on		•	
,	If approved, corrected drawings are required in rep		,	
12)	The oath or declaration is objected to by the Ex	aminer.		
Priority (under 35 U.S.C. §§ 119 and 120			
13)🖂	Acknowledgment is made of a claim for foreign	priority under 35 U.	S.C. § 119(a)-(d) or (f).	
a)	⊠ All b) Some * c) None of:			
	1.⊠ Certified copies of the priority documents	s have been receive	i .	
	2. Certified copies of the priority documents	s have been receive	in Application No	
* 5	Copies of the certified copies of the prior application from the International Burdee the attached detailed Office action for a list.	reau (PCT Rule 17.2	(a)).	
14) 🗌 A	Acknowledgment is made of a claim for domestic	c priority under 35 U	S.C. § 119(e) (to a provisional application	1).
) ☐ The translation of the foreign language pro Acknowledgment is made of a claim for domesti	• •		
Attachmen	•	-		
2) 🔲 Notic	ee of References Cited (PTO-892) se of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449) Paper No(s)	5) 🔲 Not	rview Summary (PTO-413) Paper No(s) ice of Informal Patent Application (PTO-152) er:	

Art Unit: 2871

DETAILED ACTION

1. Claims 1, 9, 12, 24, and 25 are amended.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.
- (e) the invention was described in(1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effect under this subsection of a national application published under section 122(b) only if the international application designating the United States was published under Article 21(2)(a) of such treaty in the English language; or
 (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that a patent shall not be deemed filed in the United States for the purposes of this subsection based on the filing of an international application filed under the treaty defined in section 351(a).
- 2. Claims 1-25 are rejected under 35 U.S.C. 102(e) as being anticipated by Takahashi et al (Takahashi) USPAT 6,266,119.

As to claim 1, amended, Takahashi discloses all recitations of the claim.

Takahashi discloses the nature of the alignment problem, the dimensional change due to process heating, and decreasing the error by finely adjusting a size of a mask used in the electrode pattern formation (col. 1, lines 51-67, and col. 2, lines 1-48, especially col.

0074

Art Unit: 2871

2, lines 29-39) so the pitches become substantially equal to each other during the bonding process (dimensional error reduced to acceptable magnitude).

As to claims 14 and 15, Takahashi discloses all recitations of the claim.

Takahashi discloses the nature of the alignment problem, the dimensional change due to process heating, and decreasing the error by finely adjusting a size of a mask used in the electrode pattern formation (col. 1, lines 51-67, and col. 2, lines 1-48, especially col. 2, lines 29-39) so the pitches become substantially equal to each other during the bonding process (dimensional error reduced to acceptable magnitude). Takahashi also discloses use of alignment marks on both base members with terminals therebetween (col. 9, lines 1-34 and Figure 6).

As to claims 3 and 16, Takahashi discloses the use of anisotropic conductive adhesive (col. 1, lines 51-55) and heating (col. 2, lines 29-34).

As to claims 4, 11, 17, and 23, Takahashi discloses the pitch error due to thermal expansion is greater for a flexible printed circuit (second terminal bank) is greater than that of glass (col. 2, lines 34-36), and Takahashi discloses a fine compensating adjustment (which would necessarily be to make the second terminal bank pitch smaller) to the electrode pattern formation (col. 2, lines 36-39).

Art Unit: 2871

As to claims 5-6 and 20-21, Takahashi discloses the use of polyimide film with a thickness of 15-75 µm (col. 5, lines 11-19) which overlaps the claimed range.

Takahashi discloses the dimensional error due to process heating to be generally between 0.05% and 0.1% (col. 2, lines 35-39) which would necessitate a corresponding pitch reduction range that compares to the claimed range. The expansion coefficient range would be inherent to the film material, would vary accordingly, and would affect the thermal expansion and in turn the selected pitch compensation.

As to claims 7-8 and 18-19, Takahashi discloses the use of glass (col. 1, lines 51-53) and polyimide as an example material (col. 5, lines 15-19). Substitution of similar materials is not considered patentably distinct unless unexpected results are obtained.

As to claim 22, Takahashi discloses the use of an electro-optical device in a motion picture image display (col. 9, lines 56-59), which is an electronic equipment.

As to claims 9, amended, and 10, Takahashi discloses all recitations of the claim. Takahashi discloses the nature of the alignment problem, the dimensional change due to process heating, and decreasing the error by finely adjusting a size of a mask used in the electrode pattern formation (col. 1, lines 51-67, and col. 2, lines 1-48, especially col. 2, lines 29-39) so the pitches become substantially equal to each other during the bonding process (dimensional error reduced to acceptable magnitude).

Art Unit: 2871

As to claims 12, amended, 13, 24, amended, and 25, amended, Takahashi discloses values for the expansion factors, although he assigns different letters, and Takahashi discloses the fact that these are related to the temperature of the process (heat treatment) and the material type (expansion coefficient) (col. 1, lines 51-67, and col. 2, lines 1-48, especially col. 2, lines 29-39).

Response to Amendment

3. Applicant's arguments filed 22 March 2002 have been fully considered but they are not persuasive.

Applicant's ONLY arguments are as follows:

- (1) The disclosure of "finely adjusting a size of a mask used in the electrode pattern formation" is insufficient to anticipate the method of the claimed invention.
- (2) Takahashi teaches directly away from the claimed method. Takahashi discloses a connection sheet 37 disposed between electrodes 36a and 35a.
- (3) With respect to claim 12, the pitch of the second terminal bank is a/b times the pitch of the first terminal bank.
- (4) Takahashi does not define the dimensional error in terms of a ratio between two substrates.
- (5) Takahashi is completely silent with respect to the relative pitch of the first and second terminal banks before and after thermal compression bonding as claimed.

Page 6

Application/Control Number: 09/853,083

Art Unit: 2871

Examiner's responses to Applicant's ONLY arguments are as follows:

- (1) It is respectfully pointed out that Takahashi discloses the nature of the alignment problem, the dimensional change due to process heating, and decreasing the error by finely adjusting a size of a mask used in the electrode pattern formation (col. 1, lines 51-67, and col. 2, lines 1-48, especially col. 2, lines 29-39) so the pitches become substantially equal to each other during the bonding process (dimensional error reduced to acceptable magnitude). It is also respectfully pointed out that the dimensional change that would inherently occur from heating is thermal expansion. Therefore, the only fine adjustment that would achieve Takahashi's invention would be to make the pitch smaller to compensate for the thermal expansion of the flexible printed circuit. Takahashi's disclosure is considered sufficient explanation of the thermal pitch change phenomenon and the method of compensation for said pitch change in that one of ordinary skill in the art of liquid crystals would know how to make and use the invention.
- (2) It is respectfully pointed out that the connection sheet is the flexible printed circuit that undergoes thermal expansion during heat and pressure bonding to the glass substrate.
- (3) It is respectfully pointed out that the recitation of the pitch of the second terminal bank is a/b times the pitch of the first terminal bank is merely a description of the resulting pitch adjustment needed to compensate for the expansion ratio of a/b. This is inherent to the expansion characteristics of the two materials.

Art Unit: 2871

(4) It is respectfully pointed out that Takahashi does not need to define the dimensional error in terms of a ratio between two substrates. It is clear that a ratio would exist, even if it were 1 to 1.

(5) It is respectfully pointed out that Takahashi clearly teaches the goal is to achieve <u>identical</u> pitch after thermal compression bonding in his description of the field of the invention and related art (col. 1, line 51 through col. 2, line 62, especially col. 1, lines 51-64). Takahashi's explanation of the thermally driven dimensional change issue is considered adequate disclosure of the invention for those of ordinary skill in the art of liquid crystals.

Conclusion

4. References cited but not applied are relevant to the instant application.

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

Page 8

Application/Control Number: 09/853,083

Art Unit: 2871

the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Timothy L Rude whose telephone number is (703) 305-0418. The examiner can normally be reached on Monday through Thursday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, William L Sikes can be reached on (703) 308-4842. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 308-7724 for regular communications and (703) 308-7725 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 305-4900.

TLR

August 12, 2002

Timothy L Rude Examiner Art Unit 2871

> TOANTON DRIMARY EXAMINER